Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Mohammad J. Borran	05/10/2007
Aamod Khandekar	05/22/2007
Tingfang Ji	05/21/2007

RECEIVING PARTY DATA

Name:	QUALCOMM Incorporated
Street Address:	5775 Morehouse Drive
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11620035

CORRESPONDENCE DATA

Fax Number: (858)658-2502

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Email: us-docketing@qualcomm.com Correspondent Name: **QUALCOMM** Incorporated Address Line 1: 5775 Morehouse Drive

Address Line 4: SAN DIEGO, CALIFORNIA 92121

ATTORNEY DOCKET NUMBER:	051188B1
NAME OF SUBMITTER:	Kristine U. Ekwueme

Total Attachments: 4

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PATENT **REEL: 019338 FRAME: 0753**

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PATENT REEL: 019338 FRAME: 0754

ASSIGNMENT

TO WHOM IT MAY CONCERN:

For the sum of One Dollar and other valuable consideration to us in hand paid, receipt of which is hereby acknowledged, be it known that we, Mohammad J. BORRAN, a citizen of Iran, having a place of residence at 9980 Scripps Vista Way, Unit 102, San Diego, California 92131; Aamod KHANDEKAR, a citizen of India, having a place of residence at 8465 Regents Road, #339, San Diego, California; and Tingfang JI, a citizen of P. R. China, having a place of residence at 15876 Windrose Way, San Diego, California 92127; have sold, assigned and transferred and by these presents do sell, assign, transfer and set over unto QUALCOMM Incorporated Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, its successors, legal representatives, or assigns, the whole right, title and interest in and to a certain invention relating to:

REVERSE LINK OTHER SECTOR COMMUNICATION

by us devised and the application for United States Patent therefor filed in the United States Patent and Trademark Office on January 4, 2007 and assigned Serial No. 11/620,035, including, without limitation, all provisional patent applications, including Serial No. 60/712,486, filed August 29, 2005, and all original and reissue patents granted thereof, and all divisions, and continuations thereof, including the subject matter of any and all claims which may be obtained in every such patent, and all foreign rights to said invention, and covenant that we have full right to do so, and agree that we will communicate to said corporation or its representatives all facts known to us respecting said invention, whenever requested, and testify in any legal proceedings, sign all lawful papers, make all rightful oaths and generally do everything possible to aid said corporation, its successors, assigns and nominees, to obtain and enforce proper patent protection for said invention in all countries.

[Post-Filed Asign park Multiple]

REEL: 019338 FRAME: 0755

The Commissioner of Patents and Trademarks is requested to issue the Letters Patent which may be granted for said invention or any part thereof unto said corporation in keeping with this Assignment.

Signed at San Diego, California, this	day of _	_1/1 <i>a</i> -j,2	2007
	16	1 + B.	
	Mohammad	J. Borran	
Signed at San Diego, California, this	day of _	, 2	2007
	Aamod Kha	ıdekar	
Signed at San Diego, California, this	day of _	, 2	007
	Tingfang Ji		

REEL: 019338 FRAME: 0756

which	may be granted for said invention or	any part thereof unto said co	orporation in keeping
with th	is Assignment.		
	Signed at San Diego, California, this	day of	_, 2007
		Mohammad J. Borran	
	Signed at San Diego, California, this	a day of may	_, 2007
		<u> </u>	
		Aamod Khandekar	
	Signed at San Diego, California, this	day of	_, 2007

Tingfang Ji

The Commissioner of Patents and Trademarks is requested to issue the Letters Patent

REEL: 019338 FRAME: 0757

The Commissioner of Patents and Trademarks is requested to issue the Letters Patent
which may be granted for said invention or any part thereof unto said corporation in keeping
with this Assignment.
Signed at San Diego, California, this day of, 2007
Mohammad J. Borran

Aamod Khandekar

Signed at San Diego, California, this day of day of 2007

Signed at San Diego, California, this _____ day of _____, 2007

Tingfang Ji

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RECORDED: 05/24/2007